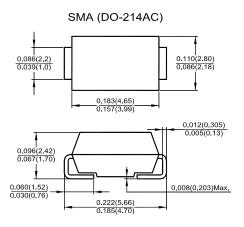
ES1A THRU ES1J

Surface Mount Superfast Recovery Rectifier Reverse Voltage – 50 to 600 V Forward Current – 1 A

Features

- Plastic package has Underwriters Laboratories
 Flammability Classification 94V-0
- · Easy pick and place
- For surface mounted applications
- Low profile package
- Built-in strain relief
- · Superfast recovery times for high efficiency



Dimensions in inches and (millimeters)

Mechanical Data

- Case: SMA (DO-214AC), molded plastic
- Terminals: Solder plated, solderable per MIL-STD-750, Method 2026 guaranteed
- · Polarity: Color band denotes cathode end

Absolute Maximum Ratings and Characteristics

Ratings at 25°C ambient temperature unless otherwise specified. Single phase, half wave, 60 Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Parameter	Symbols	ES1A	ES1B	ES1C	ES1D	ES1E	ES1G	ES1J	Units
Maximum Recurrent Peak Reverse Voltage	V _{RRM}	50	100	150	200	300	400	600	V
Maximum RMS Voltage	V _{RMS}	35	70	105	140	210	280	420	V
Maximum DC Blocking Voltage	V _{DC}	50	100	150	200	300	400	600	V
Maximum Average Forward Rectified Current T_L = 100 °C	I _{F(AV)}	1							А
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load (JEDEC Method)	I _{FSM}	30							А
Maximum Forward Voltage at 1 A	V _F	1 1.:				.25	1.7	V	
Maximum Reverse Currentat $T_A = 25 \ ^{\circ}C$ at Rated DC Blocking Voltageat $T_A = 100 \ ^{\circ}C$	l _R I _R	5 100							μA
Typical Junction Capacitance at $V_R = 4 V$, f = 1 MH _Z	CJ	10							pF
Typical Reverse Recovery Time at $I_F = 0.5 A$, $I_R = 1 A$, $I_{rr} = 0.25 A$	t _{rr}	35					50	ns	
Typical Thermal Resistance ¹⁾	R _{θJL}	35							°C/W
Operating Junction and Storage Temperature Range	T _j ,T _{stg}	- 55 to + 150							°C

¹⁾ Thermal resistance from junction to lead mounted on P.C.B. with 0.3 X 0.3" (8.0 X 8.0 mm) copper pad areas.

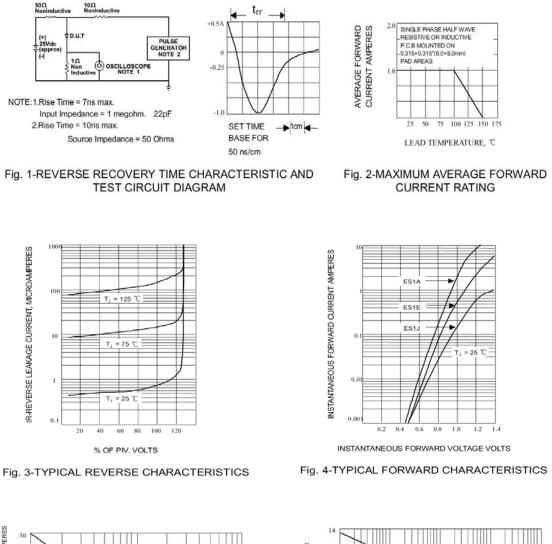
SEMTECH ELECTRONICS LTD.

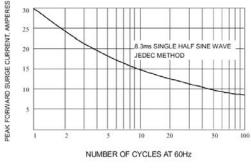
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Dated : 25/04/2011 H Rev:02







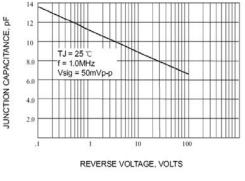


Fig. 6-TYPICAL JUNCTION CAPACITANCE





Dated : 25/04/2011 H Rev:02